

# EA1012CA07-37.400M TR

[Click part number to visit Part Number Details page](#)

## REGULATORY COMPLIANCE (Data Sheet downloaded on Jun 21, 2020)


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## ITEM DESCRIPTION

Quartz Crystal Resonator 1.0mm x 1.2mm x 0.33mm 4 Pad Ceramic Surface Mount (SMD) 37.400MHz  $\pm 30$ ppm at 25°C,  $\pm 50$ ppm over -40°C to +85°C 07pF Parallel Resonant

## ELECTRICAL SPECIFICATIONS

|                               |                                                        |
|-------------------------------|--------------------------------------------------------|
| Nominal Frequency             | 37.400MHz                                              |
| Frequency Tolerance/Stability | $\pm 30$ ppm at 25°C, $\pm 50$ ppm over -40°C to +85°C |
| Aging at 25°C                 | $\pm 3$ ppm/year Maximum                               |
| Load Capacitance              | 07pF Parallel Resonant                                 |
| Shunt Capacitance             | 5pF Maximum                                            |
| Equivalent Series Resistance  | 80 Ohms Maximum                                        |
| Mode of Operation             | AT-Cut Fundamental                                     |
| Drive Level                   | 100 $\mu$ Watts Maximum                                |
| Spurious Response             | -3dB Minimum (Measured from Fo to Fo +5000ppm)         |
| Storage Temperature Range     | -40°C to +85°C                                         |
| Insulation Resistance         | 500 Megaohms Minimum (Measured at 100Vdc)              |

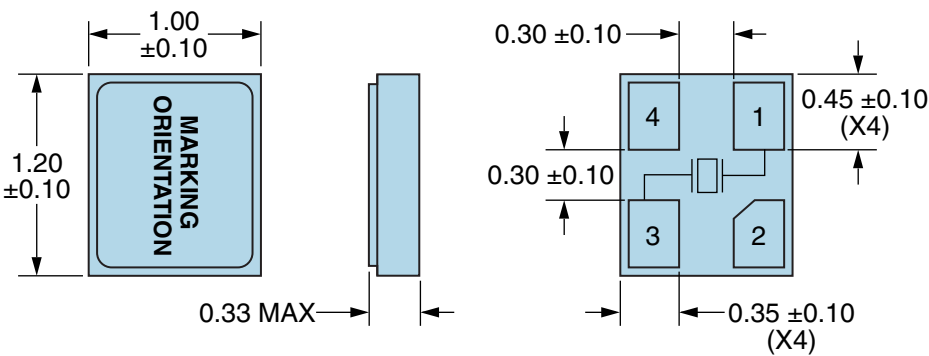
## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |                                               |
|------------------------------|-----------------------------------------------|
| ESD Susceptibility           | MIL-STD-883, Method 3015, Class 1, HBM: 1500V |
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A         |
| Flammability                 | UL94-V0                                       |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C         |
| Mechanical Shock             | MIL-STD-883, Method 2002, Condition B         |
| Moisture Resistance          | MIL-STD-883, Method 1004                      |
| Moisture Sensitivity         | J-STD-020, MSL 1                              |
| Resistance to Soldering Heat | MIL-STD-202, Method 210, Condition K          |
| Resistance to Solvents       | MIL-STD-202, Method 215                       |
| Solderability                | MIL-STD-883, Method 2003                      |
| Temperature Cycling          | MIL-STD-883, Method 1010, Condition B         |
| Vibration                    | MIL-STD-883, Method 2007, Condition A         |

EA1012CA07-37.400M TR

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MECHANICAL DIMENSIONS (all dimensions in millimeters)

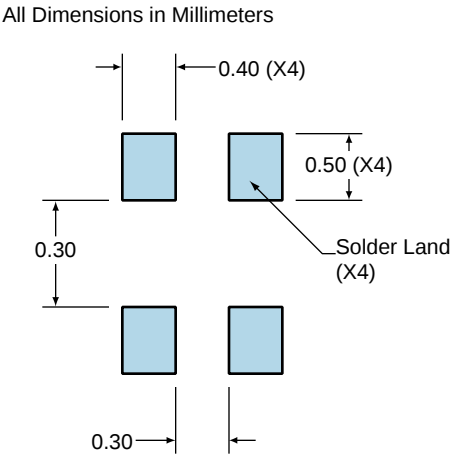


| PIN | CONNECTION   |
|-----|--------------|
| 1   | Crystal      |
| 2   | Cover/Ground |
| 3   | Crystal      |
| 4   | No Connect   |

| LINE | MARKING                                           |
|------|---------------------------------------------------|
| 1    | XXXX<br>XXXX=Ecliptek<br>Manufacturing Identifier |

Electron-Beam Sealed  
Terminal Plating Thickness: Gold (0.3 to 1.0μm) over Nickel (1.27 to 8.89μm).

Suggested Solder Pad Layout



All Tolerances are  $\pm 0.1$

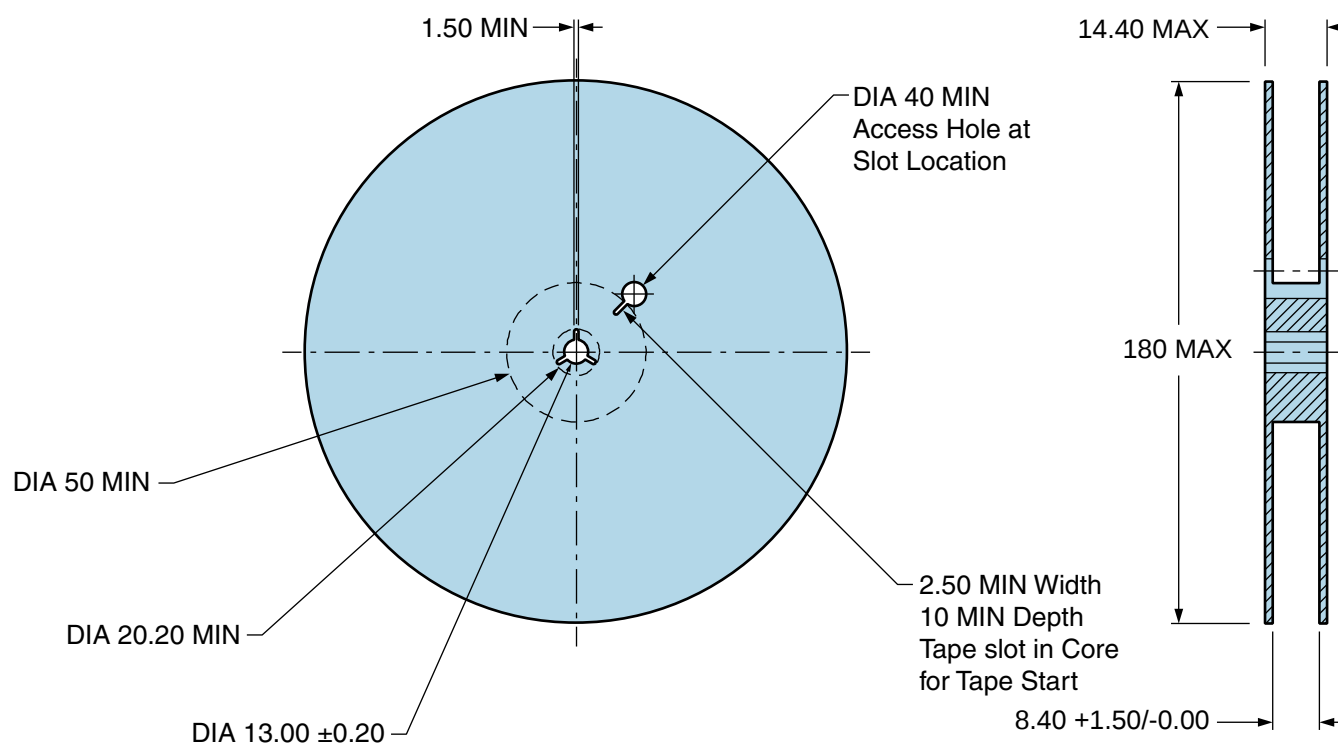
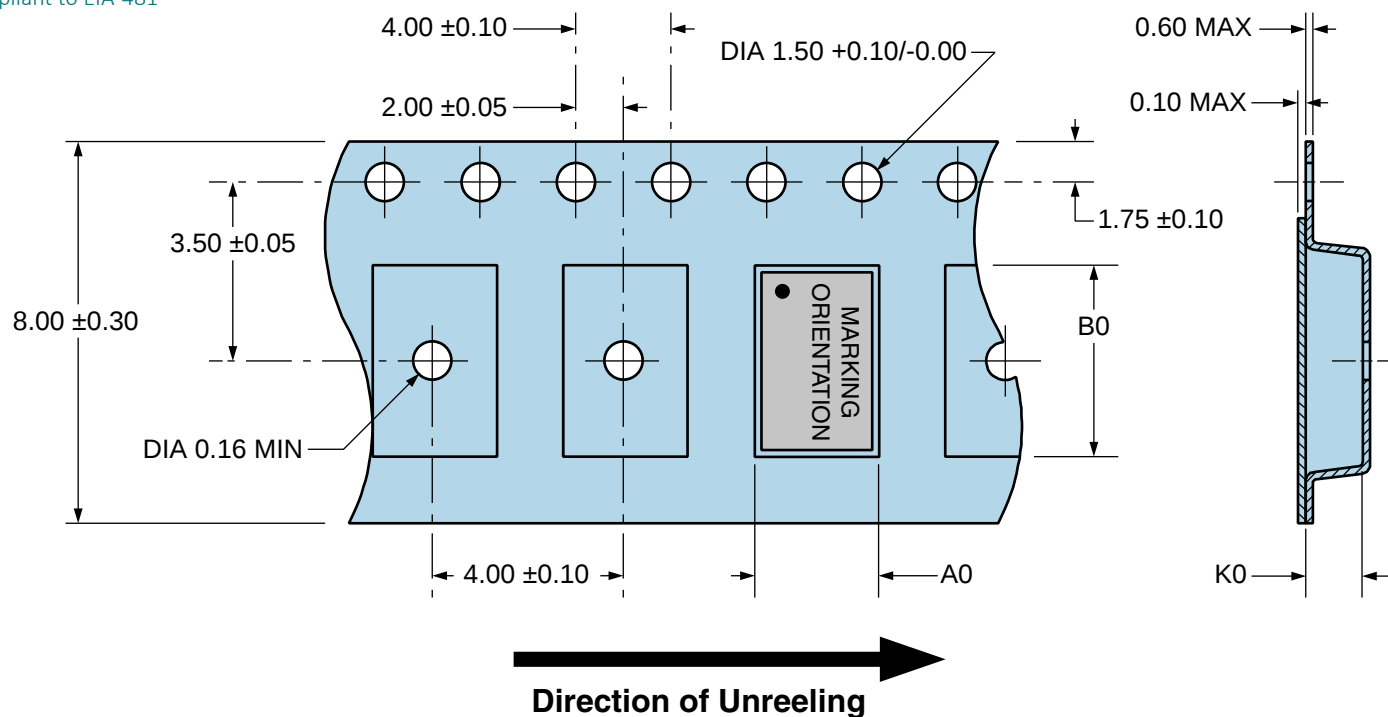
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## Tape & Reel Dimensions

Quantity Maximum Per Reel: 5,000 units

All Dimensions in Millimeters

Compliant to EIA-481



EA1012CA07-37.400M TR

[Click part number to visit Part Number Details page](#)

Recommended Solder Reflow Methods



High Temperature Infrared/Convection

|                                     |                                                   |
|-------------------------------------|---------------------------------------------------|
| Ts MAX to TL (Ramp-up Rate)         | 3°C/Second Maximum                                |
| Preheat                             |                                                   |
| - Temperature Minimum (Ts MIN)      | 150°C                                             |
| - Temperature Typical (Ts TYP)      | 175°C                                             |
| - Temperature Maximum (Ts MAX)      | 200°C                                             |
| - Time (ts MIN)                     | 60 - 180 Seconds                                  |
| Ramp-up Rate (TL to TP)             | 3°C/Second Maximum                                |
| Time Maintained Above:              |                                                   |
| - Temperature (TL)                  | 217°C                                             |
| - Time (tL)                         | 60 - 150 Seconds                                  |
| Peak Temperature (TP)               | 260°C Maximum for 10 Seconds Maximum              |
| Target Peak Temperature (TP Target) | 250°C +0/-5°C                                     |
| Time within 5°C of actual peak (tp) | 20 - 40 Seconds                                   |
| Ramp-down Rate                      | 6°C/Second Maximum                                |
| Time 25°C to Peak Temperature (t)   | 8 Minutes Maximum                                 |
| Moisture Sensitivity Level          | Level 1                                           |
| Additional Notes                    | Temperatures shown are applied to body of device. |

EA1012CA07-37.400M TR

[Click part number to visit Part Number Details page](#)

Recommended Solder Reflow Methods



Low Temperature Infrared/Convection 245°C

|                                     |                                                        |
|-------------------------------------|--------------------------------------------------------|
| TS MAX to TL (Ramp-up Rate)         | 5°C/Second Maximum                                     |
| Preheat                             |                                                        |
| - Temperature Minimum (TS MIN)      | N/A                                                    |
| - Temperature Typical (TS TYP)      | 150°C                                                  |
| - Temperature Maximum (TS MAX)      | N/A                                                    |
| - Time (ts MIN)                     | 30 - 60 Seconds                                        |
| Ramp-up Rate (TL to TP)             | 5°C/Second Maximum                                     |
| Time Maintained Above:              |                                                        |
| - Temperature (TL)                  | 150°C                                                  |
| - Time (tL)                         | 200 Seconds Maximum                                    |
| Peak Temperature (TP)               | 245°C Maximum                                          |
| Target Peak Temperature (TP Target) | 245°C Maximum 2 Times / 230°C Maximum 1 Time           |
| Time within 5°C of actual peak (tP) | 10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time |
| Ramp-down Rate                      | 5°C/Second Maximum                                     |
| Time 25°C to Peak Temperature (t)   | N/A                                                    |
| Moisture Sensitivity Level          | Level 1                                                |
| Additional Notes                    | Temperatures shown are applied to body of device.      |

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

# Mouser Electronics

Authorized Distributor

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- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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